

Chip Box - Assembled



Features:

- Manufactured from Corstat conductive corrugated fibre-board, our chip boxes provide an ESD safe and cost effective method of shipping chips and small electronic devices.
- Assembled with high density pin stick grade conductive foam.



| Product Code: | Description: | Size (mm): | Additional Notes: |
|---------------|-------------------------------|----------------|----------------------------------|
| 1687873 | Chip Box with conductive foam | 120 x 100 x 15 | Assembled / Each (Ref: 026-0466) |

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